

CHINA DEVELOPMENT BANK BENCHMARK BOND ISSUANCE PROGRAMME TENDER ANNOUNCEMENT

28 June 2021

Issue Number 210210 Tender Type Reopening **Tender Date** 29 June 2021 Tender Time 9:30 to 10:30 Offering Amount Renminbi 18 Billion Interest Type Fixed 3.41% Coupon Rate **Interest Payment Frequency** Annually 7 June Interest Payment Date Original Tenor Ten Years Maturity Date 7 June 2031 Issue and Settlement Date 2 July 2021 Dated Date(Value Date) 7 June 2021 Listing Date 6 July 2021 Clearing House China Central Depository & Clearing Co.,Ltd Market China's Inter-bank Bond Market(CIBM) Exempted for issuance in CIBM Rating

For offshore issuance, China's Quasi-sovereign ratings, i.e. Moody's: A1(Stable), S&P: A+(Stable)

*Disclaimer

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CDB's bond yield curve available at http://www.cdb.com.cn.